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IN THE UNITED STATES PATENT AND TRADEMARK OFFICE
DECLARATION FOR PATENT APPLICATION

As the below named inventor, I hereby declare that:

My residence, post office address and citizenship are as stated below next to my name.

I believe I am the original, first and sole inventor of the subject matter which is claimed and for which a patent is sought on the invention entitled:

SEMICONDUCTOR DEVICE AND METHOD FOR FABRICATING THE SAME

the specification of which was filed on July 23, 2003 as Application No. 10/625,277.

I hereby state that I have reviewed and understand the contents of the above identified specification, including the claims, as amended by an amendment, if any, specifically referred to herein.

I acknowledge the duty to disclose all information known to me that is material to patentability in accordance with Title 37, Code of Federal Regulations, § 1.56.

FOREIGN PRIORITY CLAIM

I hereby claim foreign priority benefits under Title 35, United States Code § 119(a)-(d) of any foreign application(s) for patent or inventor's certificate listed below and have also identified below any foreign application for patent or inventor's certificate having a filing date before that of the application on which priority is claimed:

- ☐ no such foreign applications have been filed
- ☒ such foreign application have been filed as follows:

EARLIEST FOREIGN APPLICATION(S), IF ANY FILED WITHIN 12 MONTHS
(6 MONTHS FOR DESIGN) PRIOR TO THIS U.S. APPLICATION

Application Number	Country	Date of Filing (dd/mm/yyyy)	Priority Claimed Under 35 USC 119
2002-71644	Republic of Korea	11/18/2002	<u>X</u> Yes No <u> </u>
2002-86189	Republic of Korea	12/30/2002	<u>X</u> Yes No <u> </u>
			<u> </u> Yes No <u> </u>

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ALL FOREIGN APPLICATION(S), IF ANY FILED MORE THAN 12 MONTHS
(6 MONTHS FOR DESIGN) PRIOR TO THIS U.S. APPLICATION

Application Number	Country	Date of Filing (dd/mm/yyyy)

CLAIM FOR BENEFIT OF EARLIER U.S. PROVISIONAL APPLICATIONS

I hereby claim priority benefits under Title 35, United States Code §119(e), of any United States provisional patent application(s) listed below:

- ☐ no such U.S. provisional applications have been filed.
- ☐ such U.S. provisional application have been filed as follows:

Application Number	Date of Filing (dd/mm/yyyy)	Priority Claimed Under 35 USC 119
		___ Yes No ___
		___ Yes No ___

CLAIM FOR BENEFIT OF EARLIER U.S./PCT APPLICATION(S)

I hereby claim the benefit under Title 35, United States Code, §120 of the United States application(s) listed below and, insofar as the subject matter of each of the claims of this application is not disclosed in the prior United States application in the manner provided by the first paragraph of Title 35, United States Code, §112, I acknowledge the duty to disclose all information that is material to patentability in accordance with Title 37, Code of Federal Regulations, §1.56 which became available to me between the filing date of the prior application and the national or PCT international filing date of this application:

- ☐ no such U.S./PCT applications have been filed.
- ☐ such U.S./PCT application have been filed as follows:

Application Number	Date of Filing (dd/mm/yyyy)

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I hereby declare that all statements made herein of my own knowledge are true and that all statements made on information and belief are believed to be true; and further that these statements were made with the knowledge that willful false statements and the like so made are punishable by fine or imprisonment, or both, under Section 1001 of Title 18 of the United States Code and that such willful false statements may jeopardize the validity of the application or any patent issued thereon.

I hereby appoint:

All practitioners at Customer Number 04743

all of **MARSHALL, GERSTEIN & BORUN LLP**, 233 S. Wacker Drive, Suite 6300, Sears Tower, Chicago, Illinois 60606-6357, jointly, and each of them severally, my attorneys at law/patent agent(s), with full power of substitution, delegation and revocation, to prosecute this application, to make alterations and amendments therein, to receive the patent, and to transact all business in the U. S. Patent and Trademark Office connected therewith.

Please mail all correspondence to Michael R. Hull, whose address is:

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Sole or first inventor's signature <i>Kim Dong Sauk</i>	Date September 20, 2004
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Full name of second inventor, if any LEE, Ho-Seok	
Second inventor's signature <i>Lee H S</i>	Date September 20, 2004
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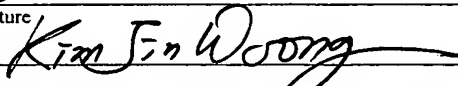
Full name of third inventor, if any PARK, Byung-Jun	
Third inventor's signature <i>Park Byung Jun</i>	Date September 20, 2004
Residence San 136-1, Ami-ri, Bubal-eub, Ichon-shi, Kyoungki-do 467-860, Republic of Korea	
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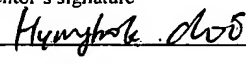
Full name of fourth inventor, if any KWON, Il-Young	
Fourth inventor's signature <i>Kwon Il Young</i>	Date September 20, 2004
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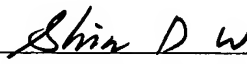
Full name of fifth inventor, if any LEE, Jong-Min	
Fifth inventor's signature <i>Lee Jong Min</i>	Date September 20, 2004
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Full name of sixth inventor, if any KIM, Hyeong-Soo	
Sixth inventor's signature <i>Kim, Hyeong Soo</i>	Date September 20, 2004
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Full name of eighth inventor, if any CHOI, Hyung-Bok	
Eighth inventor's signature 	Date September 20, 2004
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Full name of ninth inventor, if any SHIN, Dong-Woo	
Ninth inventor's signature 	Date September 20, 2004
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Full name of tenth inventor, if any	
Tenth inventor's signature	Date
Residence	
Citizenship	
Mailing Address	